

■Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	G3VM-2L G3VM-2FL	G3VM-WL G3VM-WFL	G3VM-351GL	Unit	Measurement conditions
Input	LED forward current	IF	50			mA	
	Repetitive peak LED forward current	IFP	1			A	100 μs pulses, 100 pps
	LED forward current reduction rate	ΔIF/°C	-0.5			mA/°C	Ta ≥ 25°C
	LED reverse voltage	VR	6		5	V	
	Connection temperature	TJ	125			°C	
Output	Load voltage (AC peak/DC)	VOFF	350			V	
	Continuous load current (AC peak/DC)	Io	120			mA	
	ON current reduction rate	ΔIo/°C	-1.2			mA/°C	Ta ≥ 25°C
	Connection temperature	TJ	125			°C	
Dielectric strength between I/O *		VI-O	2500		1500	Vrms	AC for 1 min
Ambient operating temperature		Ta	-40 to +85			°C	With no icing or condensation
Ambient storage temperature		Tstg	-55 to +125			°C	
Soldering temperature		—	260			°C	10 s

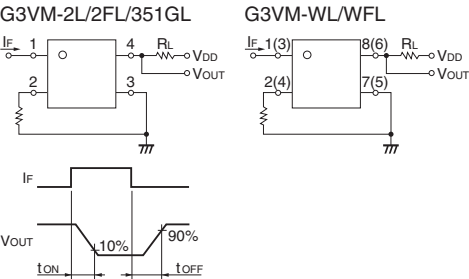
* The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

DIP
G3VM-□L/□FL/□GL

■Electrical Characteristics (Ta = 25°C)

Item		Symbol		G3VM-2L G3VM-2FL	G3VM-WL G3VM-WFL	G3VM-351GL	Unit	Measurement conditions
Input	LED forward voltage	V _F	Minimum	1.0		V	I _F =10 mA	
			Typical	1.15				
			Maximum	1.3				
	Reverse current	I _R	Maximum	10		μA	G3VM-2L/2FL/WL/WFL : V _R =6 V G3VM-351GL : V _R =5 V	
	Capacitance between terminals	C _T	Typical	30		pF	V=0, f=1 MHz	
	Trigger LED forward current	I _{FT}	Typical	1		mA	I _O =120 mA	
			Maximum	3				
Release LED forward current	I _{FC}	Minimum	0.1		mA	G3VM-2L/2FL/WL/WFL : I _{OFF} =10 μA G3VM-351GL : I _{OFF} =100 μA		
Output	Maximum resistance with output ON	R _{ON}	Typical	22	15	Ω	I _F =5 mA, I _O =120 mA	
			Maximum	35				
	Current leakage when the relay is open	I _{LEAK}	Maximum	1.0		μA	V _{OFF} =350 V	
	Capacitance between terminals	C _{OFF}	Typical	40	70	pF	V=0, f=1 MHz	
Limit current		I _{LIM}	Minimum	150		mA	I _F =5 mA, V _{DD} =5 V, t=5 ms	
			Maximum	300				
Capacitance between I/O terminals		C _{I-O}	Typical	0.8		pF	f=1 MHz, V _S =0 V	
Insulation resistance between I/O terminals		R _{I-O}	Minimum	1000		MΩ	V _{I-O} =500 VDC, R _{oH} ≤60%	
			Typical	10 ⁸				
Turn-ON time		t _{ON}	Typical	—	0.3	ms	I _F =5 mA, R _L =200 Ω, V _{DD} =2 V *	
			Maximum	1.0				
Turn-OFF time		t _{OFF}	Typical	—	0.1	ms	I _F =5 mA, R _L =200 Ω, V _{DD} =2 V *	
			Maximum	1.0				

* Turn-ON and Turn-OFF Times



■Recommended Operating Conditions

For usage with high reliability, Recommended Operation Conditions is a measure that takes into account the derating of Absolute Maximum Ratings and Electrical Characteristics.

Each item on this list is an independent condition, so it is not simultaneously satisfy several conditions.

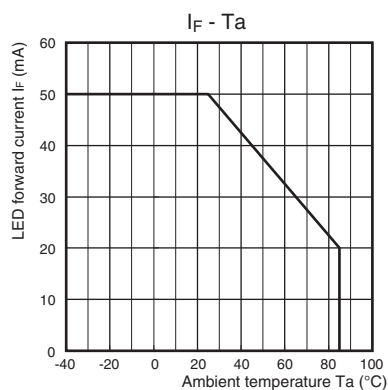
Item	Symbol		G3VM-2L G3VM-2FL	G3VM-WL G3VM-WFL	G3VM-351GL	Unit
Load voltage (AC peak/DC)	V _{DD}	Maximum	280			V
Operating LED forward current	I _F	Minimum	5			mA
		Typical	7.5			
		Maximum	25			
Continuous load current (AC peak/DC)	I _O	Maximum	100			A
Ambient operating temperature	T _a	Minimum	-20			°C
		Maximum	65			

■Spacing and Insulation

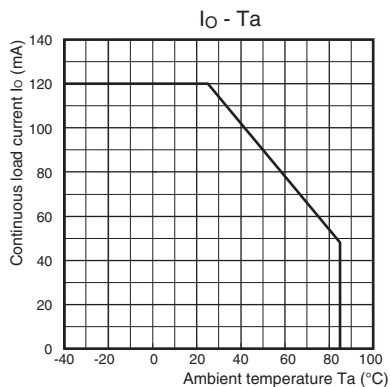
Item	Minimum		Unit
	G3VM-□L/□FL	G3VM-□GL	
Creepage distances	7.0	2.5	mm
Clearance distances	7.0	2.5	
Internal isolation thickness	0.4	0.1	

Engineering Data

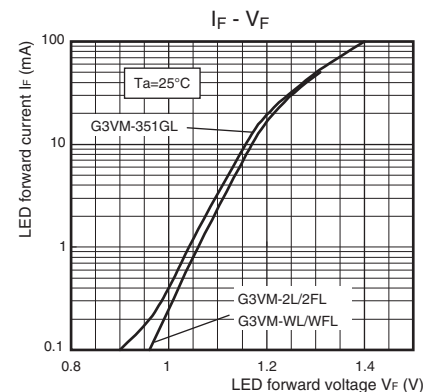
LED forward current vs. Ambient temperature



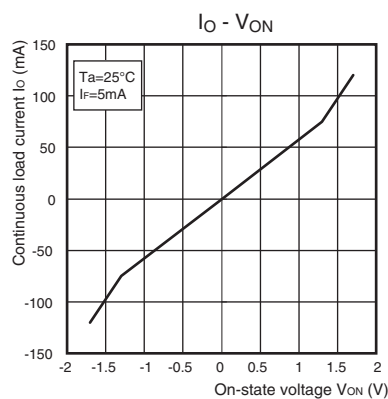
Continuous load current vs. Ambient temperature



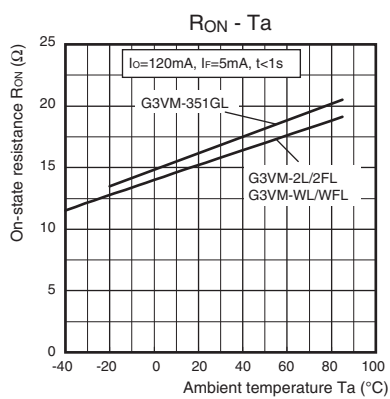
LED forward current vs. LED forward voltage



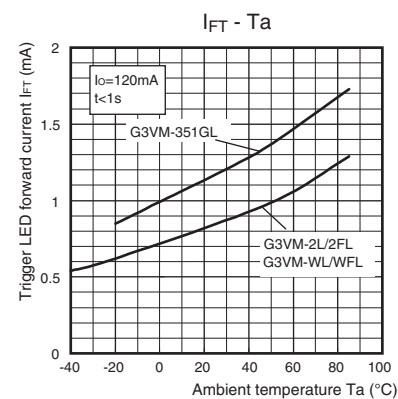
Continuous load current vs. On-state voltage



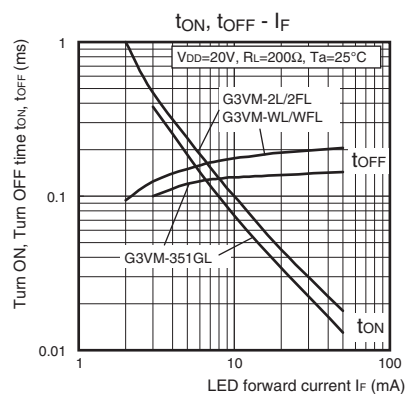
On-state resistance vs. Ambient temperature



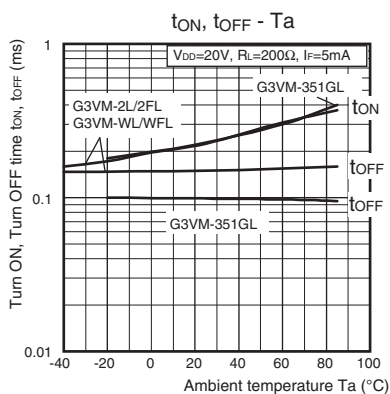
Trigger LED forward current vs. Ambient temperature



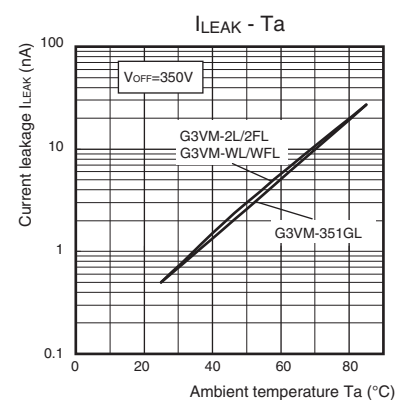
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature

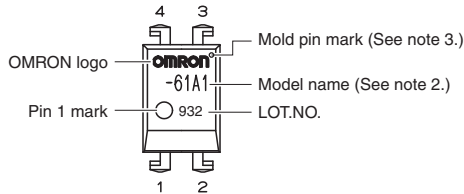


■Appearance / Terminal Arrangement / Internal Connections

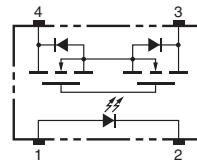
●Appearance

DIP (Dual Inline Package)

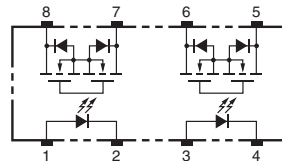
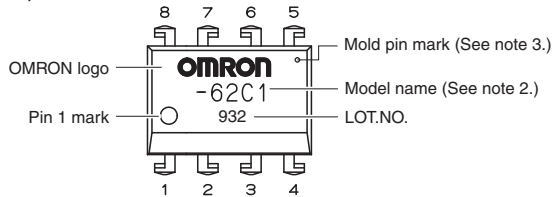
DIP 4-pin



●Terminal Arrangement/Internal Connections (Top View)

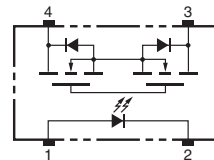
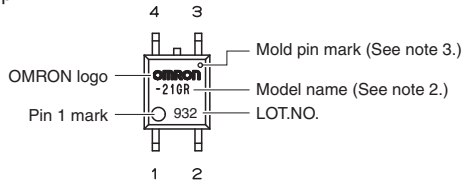


DIP 8-pin



SOP (Small Outline Package)

SOP 4-pin



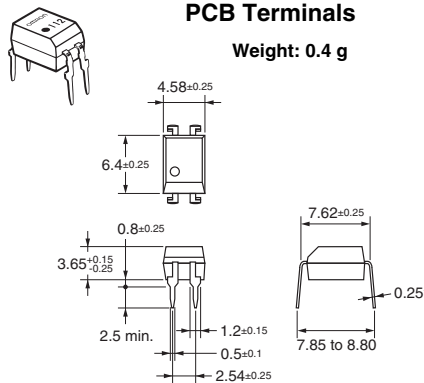
Note: 1. The actual product is marked differently from the image shown here.
Note: 2. "G3VM" does not appear in the model number on the Relay.
Note: 3. The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

■Dimensions (Unit: mm)

G3VM-2L

PCB Terminals

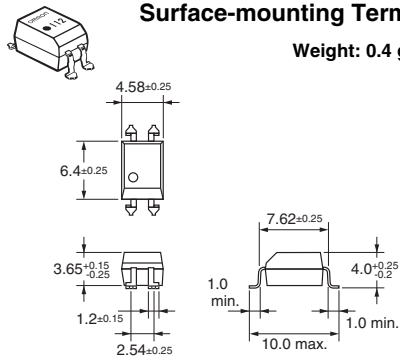
Weight: 0.4 g



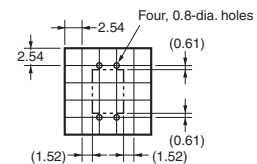
G3VM-2FL

Surface-mounting Terminals

Weight: 0.4 g

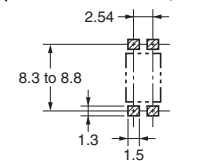


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)

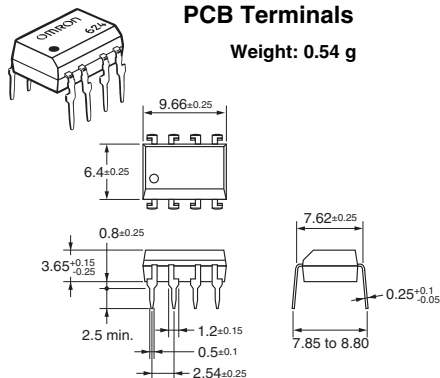


Note: The actual product is marked differently from the image shown here.

G3VM-WL

PCB Terminals

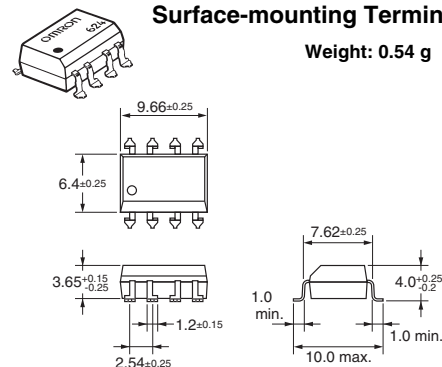
Weight: 0.54 g



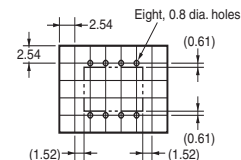
G3VM-WFL

Surface-mounting Terminals

Weight: 0.54 g

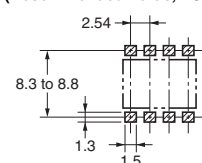


PCB Dimensions (BOTTOM VIEW)



Actual Mounting Pad Dimensions

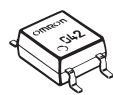
(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

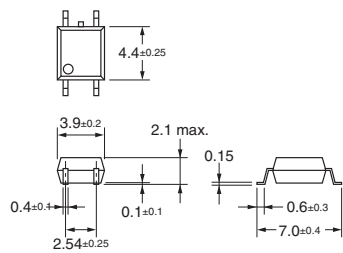
■Dimensions (Unit: mm)

G3VM-351GL

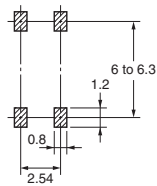


Surface-mounting Terminals

Weight: 0.1 g




Actual Mounting Pad Dimensions
(Recommended Value, TOP VIEW)



Note: The actual product is marked differently from the image shown here.

■Approved Standards

UL recognized 

Model	Approved Standards	Contact form	File No.
G3VM-2L G3VM-2FL	UL (recognized)	1a (SPST-NO)	E80555
G3VM-WL G3VM-WFL		2a (DPST-NO)	

■Safety Precautions

- Refer to the *Common Precautions for All MOS FET Relays* for precautions that apply to all MOS FET Relays.

DIP

G3VM-□L/□FL/□GL

Please check each region's Terms & Conditions by region website.

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Electronic and Mechanical Components Company

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